



COAXIAL SOLID-STATE

High Power Amplifier

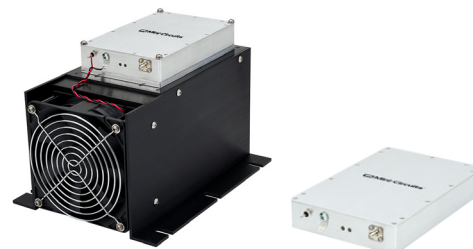
ZHL6G018G020+ ZHL6G018G020X+

Mini-Circuits

50Ω 20W 6 to 18 GHz

THE BIG DEAL

- High output power, 20W
- 6 to 18 GHz ultra broadband
- Suitable for modulated, CW, and pulsed signals
- High power gain, 40 dB typical
- No damage with VSWR of 3:1
- Protected against: reverse polarity, over voltage, high temperature



Generic photo used for illustration purposes only

APPLICATIONS

- High Power test sets
- Burn-in systems
- 5G
- Wi-Fi
- Communications
- Radar

Model No.	ZHL6G018G020+	ZHL6G018G020X+
Option	With Heatsink & Fan	Without Heatsink & Fan
Case Style	BT3013	
Connectors	IN: SMA-Female, OUT: 2.92mm-Female	

+RoHS Compliant
 The +Suffix identifies RoHS Compliance.
 See our website for methodologies and qualifications

PRODUCT OVERVIEW

ZHL6G018G020X+ is a Class AB, high power amplifier providing 20W (typical) of saturated output power over the 6 to 18 GHz band, ideal for a variety of high power test setups as well as applications including communications, radar and more. This ruggedly designed amplifier provides unconditional stability and built-in self-protection against reverse polarity, over voltage and overheating. It is capable of withstanding a VSWR of 3:1 at 20W P_{OUT}. Housed in a rugged aluminum alloy case measuring 6 x 4 x 1", the unit features SMA connectors and an optional heat sink and fan attachment for cooling.

KEY FEATURES

Feature	Advantages
Rugged design	No damage into a VSWR of 3:1 at 20W output power
Internal protection	High temperature, over voltage and reverse polarity.
Large frequency range	Large instantaneous frequency range covers 6-18 GHz with one amplifier.
High power gain	Enables signal amplification to 10W output without the need for multiple gain stages. The amplifier has a typical power gain of 40 dB at 0 dBm input power.
Unconditional stability	Provides reliable performance independent of input and load conditions.



ELECTRICAL SPECIFICATIONS AT T_{MOUNTING BASE}=+25°C, V_{DS}=20V, 50Ω SYSTEM

Parameter	Symbol	Condition	ZHL6G018G020+			ZHL6G018G020X+			Units
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range	f		6000	—	17000	17000	—	18000	MHz
Output Power	P _{OUT}	CW @ P _{IN} <8dBm	13.8	25.7	—	8.9	13.5	—	W
			41.4	44.1	—	39.5	41.3	—	dBm
Small Signal Gain	G _{SS}	CW @ P _{IN} =-30dBm	45	57	—	43	48	—	dB
Small Signal Gain Flatness	G _{SS-FLAT}	CW @ P _{IN} =-30dBm	—	±6	±7	—	±3	±7	dB
Power Gain	G _P	CW @ P _{IN} <8dBm	—	34.5	—	—	33.8	—	dB
Power Gain Flatness	G _{P-FLAT}	CW @ P _{IN} =8dBm	—	±5	±5	—	±5	±5	dBm
Noise Figure	NF		—	8	10	—	8	10	dB
Input Return Loss	IRL	CW @ P _{IN} =-30dBm	7.5	15	—	7.5	19	—	dB
Harmonics	H2, H3	CW @ P _{IN} =<8dBm	—	-10	—	—	-10	—	dBc
Spurious Signals	Spur	CW @ P _{IN} =<8dBm	—	—	-60	—	—	-60	dBc
DC Supply Voltage	V _{DC}		—	20 ¹	22	—	20 ¹	22	V
DC Supply Current	I _{DC}		—	6	8	—	6	8	A

1. Recommend Operating Voltage

MAXIMUM RATINGS

Parameter	Ratings
Operating Mounting Base Temperature	-20°C to +60°C
Storage Temperature	-55°C to +100°C
DC Voltage	22V
Input RF Power (no damage)	+10 dBm
Output RF Power	+44 dBm (6 to 17 GHz) +43 dBm (17 to 18 GHz)
Ruggedness through all phases at P _{OUT} =20W CW	VSWR=3:1, 2 minutes



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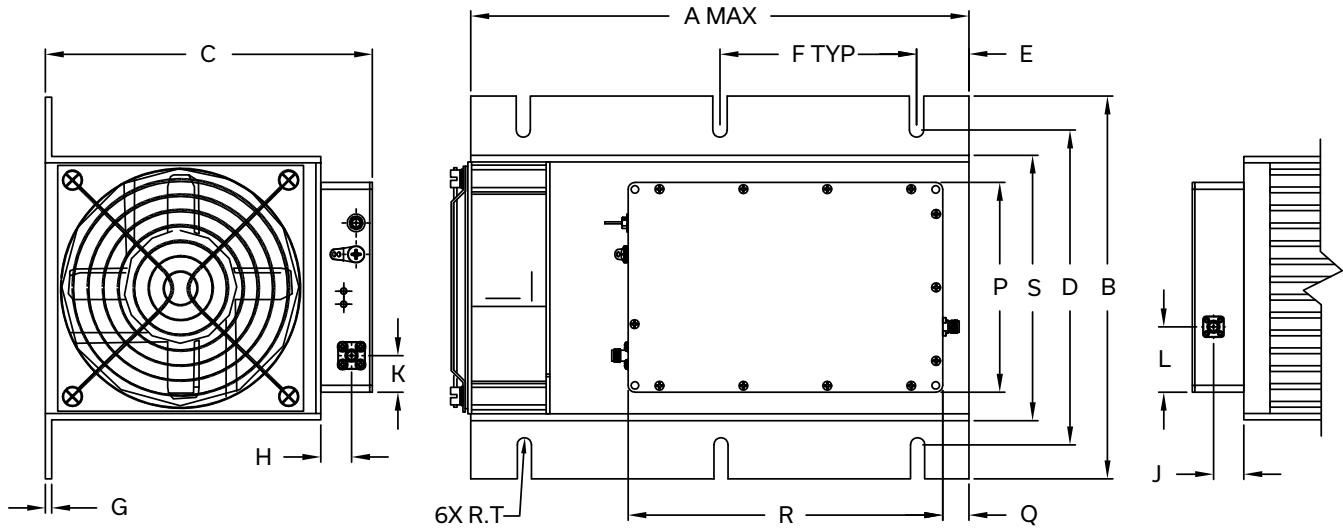
High Power Amplifier

ZHL6G018G020+
ZHL6G018G020X+

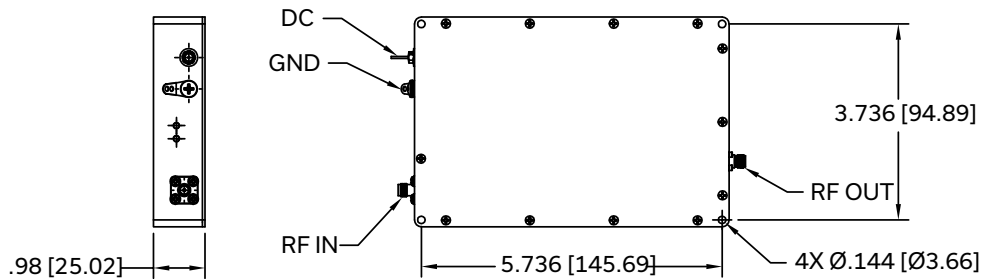
Mini-Circuits

50Ω 20W 6 to 18 GHz

OUTLINE DRAWING FOR MODELS WITH HEATSINK & FAN (ZHL6G018G020+)



MOUNTING INFORMATION FOR MODELS WITHOUT HEATSINK & FAN (ZHL6G018G020X+)



Dimensions in inches [mm]

OUTLINE DIMENSIONS

	A	B	C	D	E	F	G	H	J	K	L	M	N	P	Q	R	S	T	wt
inches	9.85	7.3	6.23	6.00	1.0	3.75	0.13	0.59	0.58	0.70	1.25	—	—	4.00	0.50	6.00	5.1	0.135	grams*
mm	250.19	185.42	158.24	152.40	25.40	95.25	3.30	14.99	14.73	17.78	31.75	—	—	101.60	12.70	152.40	129.54	3.43	4265

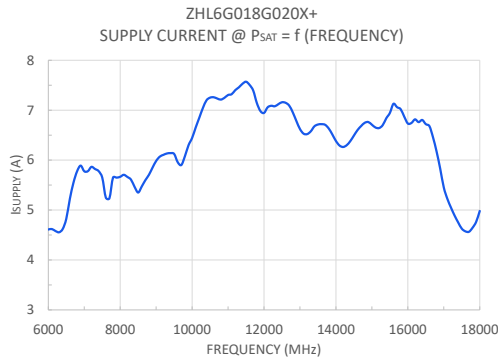
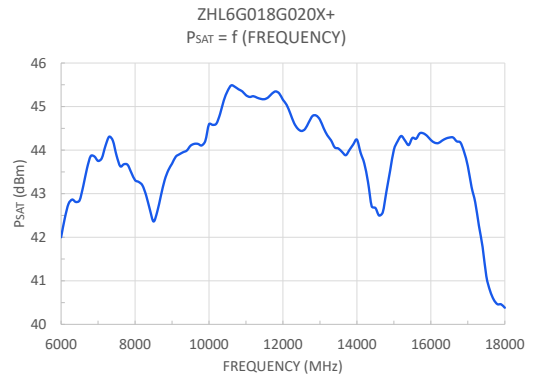
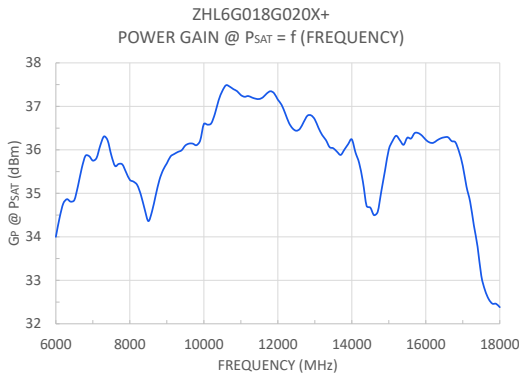
*580 grams without heatsink





TYPICAL PERFORMANCE DATA/CURVES

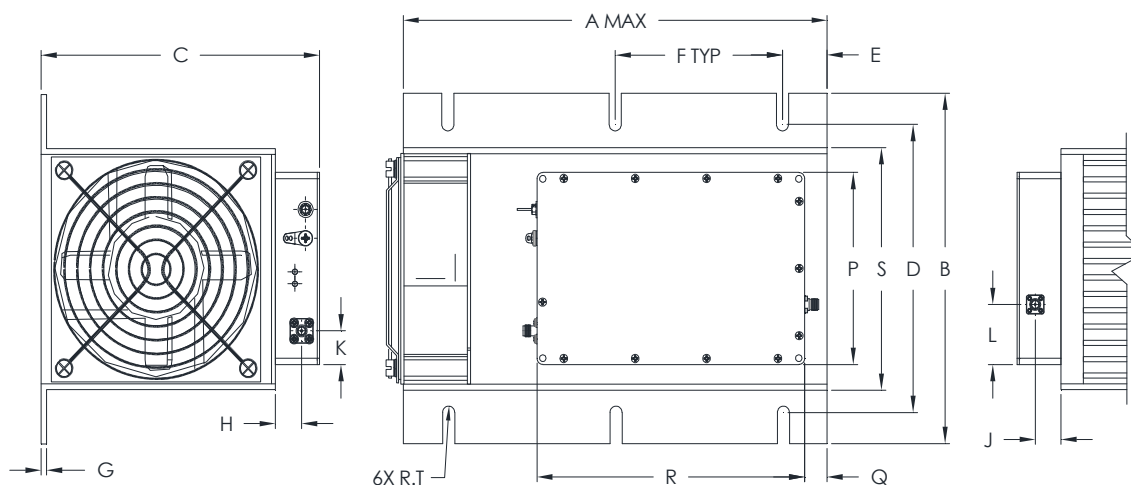
Frequency (MHz)	Power Gain (dB)	P _{SAT} (dBm)	Supply Current (A)
6000	34.00	42.00	4.61
7000	35.75	43.75	5.78
8000	35.31	43.31	5.67
9000	35.69	43.69	5.98
10000	36.59	44.59	6.44
11000	37.26	45.26	7.30
12000	37.15	45.15	6.95
13000	36.70	44.70	6.62
14000	36.24	44.24	6.38
15000	36.01	44.01	6.71
16000	36.23	44.23	6.73
17000	35.63	43.63	5.45
18000	32.38	40.38	4.98



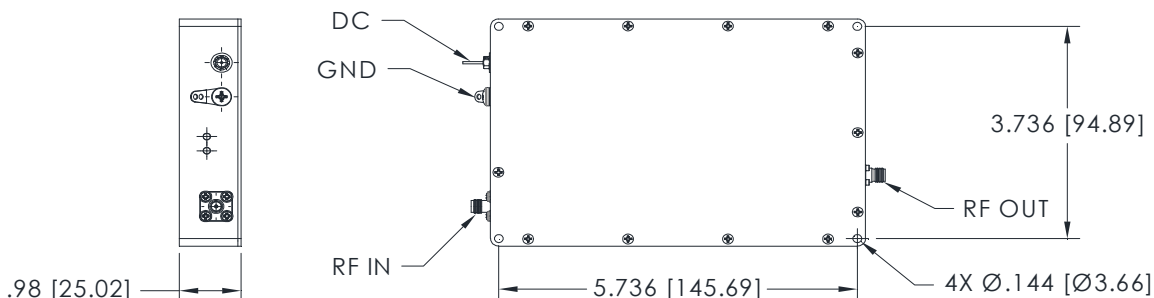
- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

Outline Dimensions

BT3013



MOUNTING INFORMATION FOR MODELS WITHOUT HEATSINK



CASE#	A	B	C	D	E	F	G	H	J	K	L	M	N
BT3013	9.85 (250.19)	7.3 (185.42)	6.23 (158.24)	6.00 (152.40)	1.00 (25.40)	3.75 (95.25)	.13 (3.30)	.59 (14.99)	.58 (14.73)	.70 (17.78)	1.25 (31.75)	-	-

CASE#	P	Q	R	S	T	WT, GRAM	WT WITHOUT HEATSINK, GRAM
BT3013	4.00 (101.6)	.50 (12.70)	6.00 (152.40)	5.1 (129.54)	.135 (3.43)	4265	580

Dimensions in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Case material: Aluminum alloy.
2. Finish:
For RoHS Case Styles: Clear Chemical conversion coating, non-chrome or trivalent chrome based.
3. Heatsink finish: Black anodize.
4. Refer to the individual model data sheet for the type of connectors available.
5. Recommended screws for mounting model without heat sink on 3/32" thick sheet: #6-32, 1.25" Length.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 60°C	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Stabilization Bake	(Non-operating) 125°C, 24 hours	- - -
Burn-in at Elevated Temp.	(DC on) 72 hours at 70° C base plate Temperature	MIL-STD-202, Method 108
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A, except 100°C